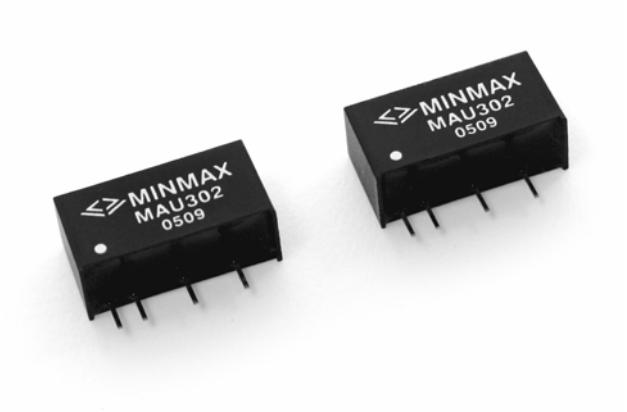
MAU300 Series

2W, Miniature SIP, Single & Dual Output DC/DC Converters

Key Features

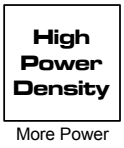
- *Efficiency up to 83%*
- *1000VDC Isolation*
- *MTBF > 2,000,000 Hours*
- *Low Cost*
- *Input 5, 12 and 24VDC*
- *Output 3.3, 5, 12, 15, ±5, ±12 and ±15VDC*
- *Temperature Performance −40°C to +85°C*
- *UL 94V−0 Package Material*
- *Internal SMD Construction*
- *Industry Standard Pinout*



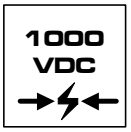
Minmax's MAU300 DC/DC's are specially designed to provide higher power to 2W in a miniature SIP package.

The series consists of 21 models with input voltages of 5V, 12V and 24VDC which offers standard output voltages of 3.3V, 5V, 12V, 15V, ±5V, ±12V and ±15VDC for a wide choice.

The MAU300 series is an excellent selection for a variety of applications including distributed power systems, mixed analog/digital subsystems, portable test equipments, local power networks and battery backed systems.

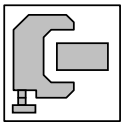


More Power



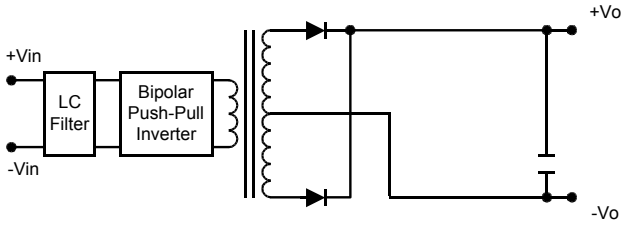
I/O Isolation

Low Cost

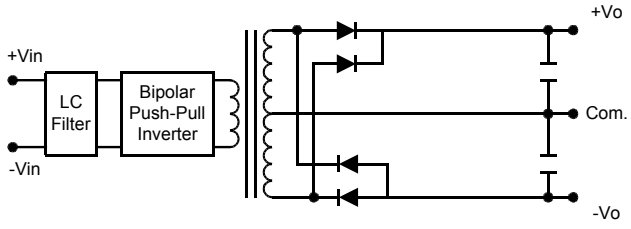

Low Profile

Block Diagram

Single Output



Dual Output



Model Selection Guide

Model Number	Input Voltage	Output Voltage	Output Current		Input Current		Load Regulation	Efficiency
			Max.	Min.	@Max. Load	@No Load		@Max. Load
	VDC	VDC	mA	mA	mA (Typ.)	mA (Typ.)	% (Max.)	% (Typ.)
MAU301	5 (4.5 ~ 5.5)	3.3	500	10	452	60	11	73
MAU302		5	400	8	526		11	76
MAU303		12	165	3	495		7	80
MAU304		15	133	2.5	499		7	80
MAU305		±5	±200	±4	519		10	77
MAU306		±12	±83	±1.5	504		7	79
MAU307		±15	±66	±1	501		7	79
MAU311	12 (10.8 ~ 13.2)	3.3	500	10	185	30	8	74
MAU312		5	400	8	212		8	78
MAU313		12	165	3	200		5	82
MAU314		15	133	2.5	200		5	83
MAU315		±5	±200	±4	210		8	79
MAU316		±12	±83	±1.5	201		5	82
MAU317		±15	±66	±1	200		5	82
MAU321	24 (21.6 ~ 26.4)	3.3	500	10	92	15	8	74
MAU322		5	400	8	108		8	77
MAU323		12	165	3	101		5	81
MAU324		15	133	2.5	101		5	82
MAU325		±5	±200	±4	105		8	79
MAU326		±12	±83	±1.5	102		5	81
MAU327		±15	±66	±1	100		5	82

Absolute Maximum Ratings

Parameter		Min.	Max.	Unit
Input Surge Voltage (1000 mS)	5VDC Input Models	−0.7	9	VDC
	12VDC Input Models	−0.7	18	VDC
	24VDC Input Models	−0.7	30	VDC
Lead Temperature (1.5mm from case for 10 Sec.)		−−−	260	℃
Internal Power Dissipation		−−−	650	mW

Exceeding the absolute maximum ratings of the unit could cause damage. These are not continuous operating ratings.

Environmental Specifications

Parameter	Conditions	Min.	Max.	Unit
Operating Temperature	Ambient	−40	+85	℃
Operating Temperature	Case	−40	+90	℃
Storage Temperature		−40	+125	℃
Humidity		−−−	95	%
Cooling	Free−Air Convection			

Notes :

1. Specifications typical at Ta=+25℃, resistive load, nominal input voltage, rated output current unless otherwise noted.
2. Ripple & Noise measurement bandwidth is 0−20 MHz.
3. These power converters require a minimum output loading to maintain specified regulation.
4. Operation under no−load conditions will not damage these modules; however, they may not meet all specifications listed.
5. All DC/DC converters should be externally fused at the front end for protection.
6. Other input and output voltage may be available, please contact factory.
7. Specifications subject to change without notice.

Input Specifications

Parameter	Model	Min.	Typ.	Max.	Unit
Start Voltage Range	5V Input Models	4.5	5	5.5	VDC
	12V Input Models	10.8	12	13.2	
	24V Input Models	21.6	24	26.4	
Reverse Polarity Input Current	All Models	---	---	0.3	A
Input Filter		Pi Filter			

Output Specifications

Parameter	Conditions	Min.	Typ.	Max.	Unit
Output Voltage Accuracy		---	±1.0	±3.0	%
Output Voltage Balance	Dual Output, Balanced Loads	---	±0.1	±1.0	%
Line Regulation	For Vin Change of 1%	---	±1.2	±1.5	%
Load Regulation	Io=20% to 100%	See Model Selection Guide			%
Ripple & Noise (20MHz)		---	100	150	mV P-P
Ripple & Noise (20MHz)	Over Line, Load & Temp.	---	---	200	mV P-P
Ripple & Noise (20MHz)		---	---	5	mV rms
Over Load		120	---	---	%
Temperature Coefficient		---	±0.01	±0.02	%/°C
Output Short Circuit	0.5 Second Max.				

General Specifications

Parameter	Conditions	Min.	Typ.	Max.	Unit
Isolation Voltage Rated	60 Seconds	1000	---	---	VDC
Isolation Voltage Test	Flash Tested for 1 Second	1100	---	---	VDC
Isolation Resistance	500VDC	1000	---	---	MΩ
Isolation Capacitance	100KHz,1V	---	80	120	pF
Switching Frequency		50	80	100	KHz
MTBF	MIL-HDBK-217F @ 25°C, Ground Benign	2000	---	---	K Hours

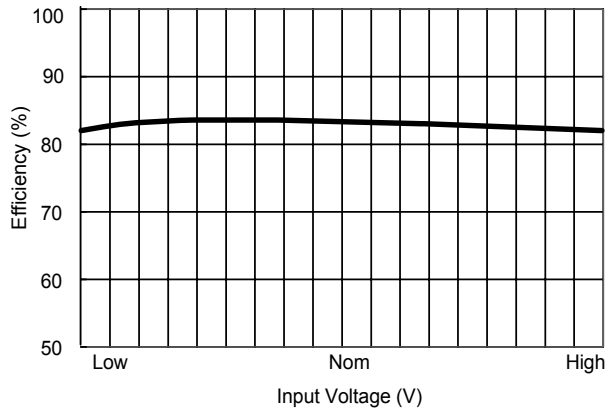
Capacitive Load

Models by Vout	3.3V	5V	12V	15V	±5V #	±12V #	±15V #	Unit
Maximum Capacitive Load	470	470	470	470	390	390	390	uF

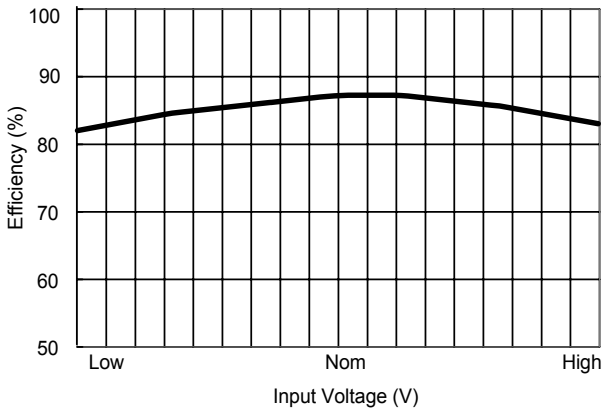
 # For each output

Input Fuse Selection Guide

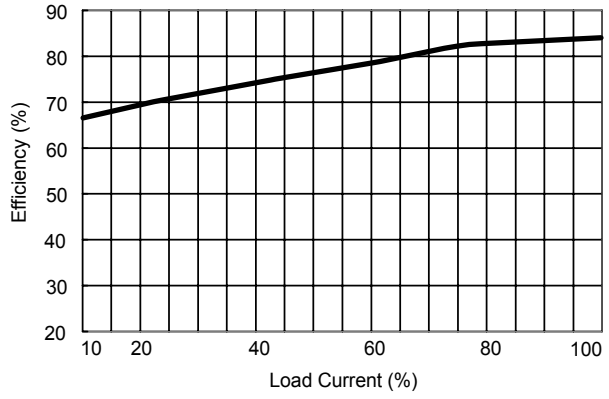
5V Input Models	12V Input Models	24V Input Models
1000mA Slow - Blow Type	500mA Slow - Blow Type	200mA Slow - Blow Type



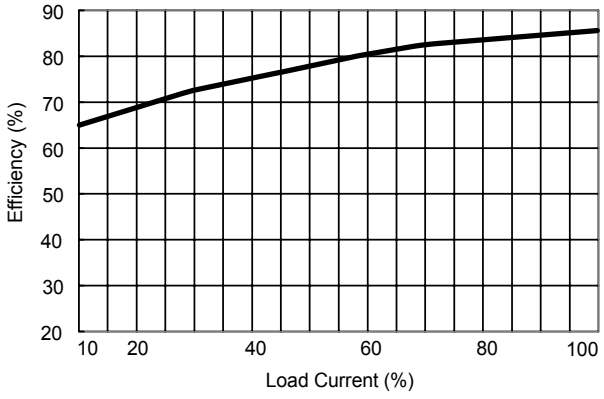
Efficiency vs Input Voltage (Single Output)



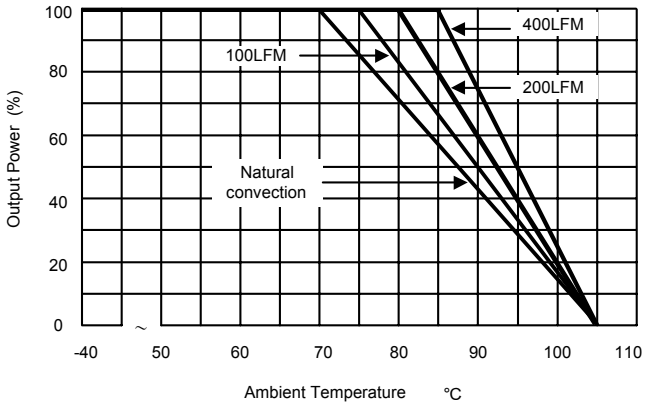
Efficiency vs Input Voltage (Dual Output)



Efficiency vs Output Load (Single Output)



Efficiency vs Output Load (Dual Output)



Derating Curve

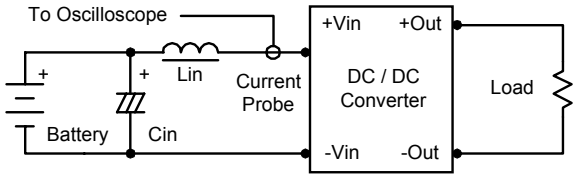
Test Configurations

Input Reflected-Ripple Current Test Setup

Input reflected−ripple current is measured with a inductor Lin (4.7uH) and Cin (220uF, ESR < 1.0Ω at 100 KHz) to simulate source impedance.

Capacitor Cin, offsets possible battery impedance.

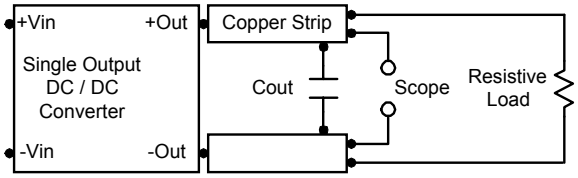
Current ripple is measured at the input terminals of the module, measurement bandwidth is 0−500 KHz.

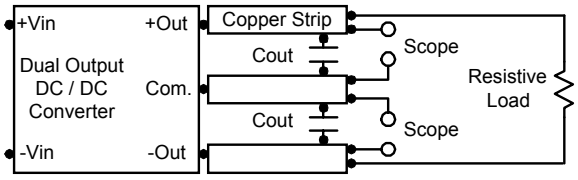


Peak-to-Peak Output Noise Measurement Test

Use a Cout 0.33uF ceramic capacitor.

Scope measurement should be made by using a BNC socket, measurement bandwidth is 0−20 MHz. Position the load between 50 mm and 75 mm from the DC/DC Converter.





Design & Feature Considerations

Maximum Capacitive Load

The MAU300 series has limitation of maximum connected capacitance at the output.

The power module may be operated in current limiting mode during start−up, affecting the ramp−up and the startup time.

For optimum performance we recommend 390uF maximum capacitive load for dual outputs and 470uF capacitive load for single outputs.

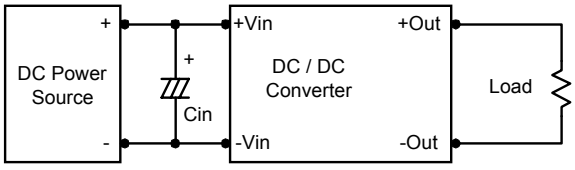
The maximum capacitance can be found in the data sheet.

Input Source Impedance

The power module should be connected to a low ac−impedance input source. Highly inductive source impedances can affect the stability of the power module.

In applications where power is supplied over long lines and output loading is high, it may be necessary to use a capacitor at the input to ensure startup.

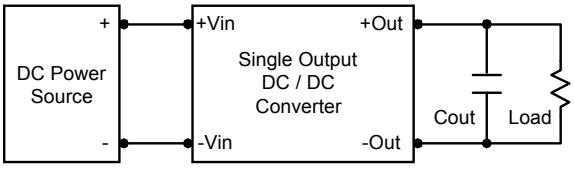
Capacitor mounted close to the power module helps ensure stability of the unit, it is comended to use a good quality low Equivalent Series Resistance (ESR < 1.0Ω at 100 KHz) capacitor of a 2.2uF for the 5V input devices, a 1.0uF for the 12V input devices and a 0.47uF for the 24V devices.

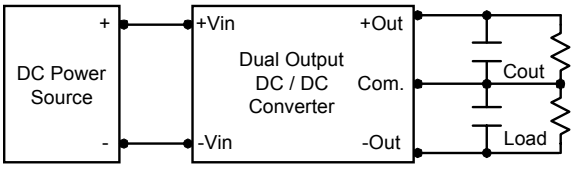


Output Ripple Reduction

A good quality low ESR capacitor placed as close as practicable across the load will give the best ripple and noise performance.

To reduce output ripple, it is recommended to use 1.5uF capacitors at the output.

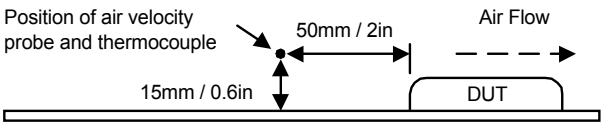




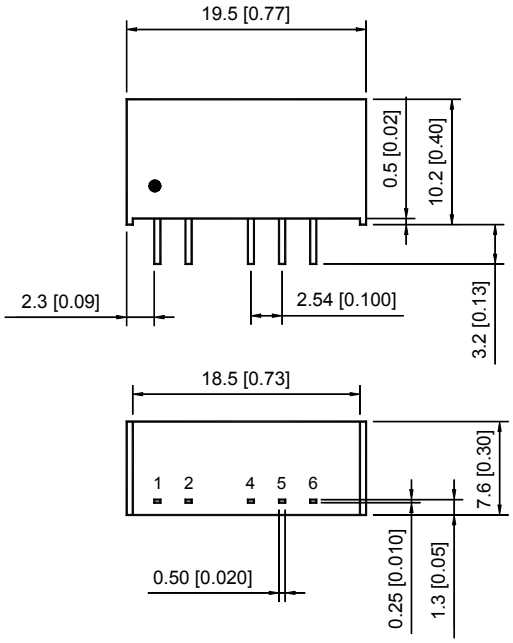
Thermal Considerations

Many conditions affect the thermal performance of the power module, such as orientation, airflow over the module and board spacing. To avoid exceeding the maximum temperature rating of the components inside the power module, the case temperature must be kept below 90°C.

The derating curves are determined from measurements obtained in an experimental apparatus.



Mechanical Dimensions

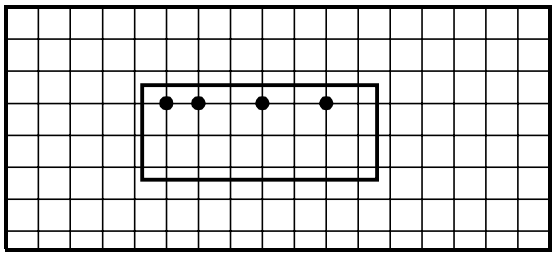


Tolerance	Millimeters	Inches
	X.X±0.25	X.XX±0.01
	X.XX±0.13	X.XXX±0.005
Pin	±0.05	±0.002

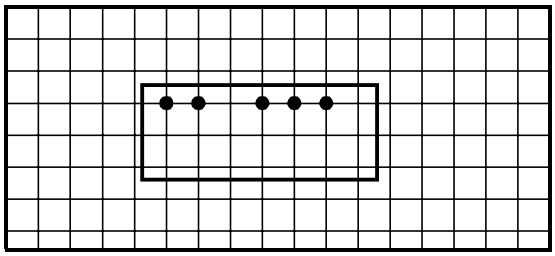
Connecting Pin Patterns

Bottom View (2.54 mm / 0.1 inch grids)

Single Output



Dual Output



Pin Connections

Pin	Single Output	Dual Output
1	+Vin	+Vin
2	−Vin	−Vin
4	−Vout	−Vout
5	No Pin	Common
6	+Vout	+Vout

Physical Characteristics

Case Size : 19.5×7.6×10.2 mm
0.77×0.30×0.40 inches

Case Material : Non−Conductive Black Plastic

Weight : 2.7g

The MAU300 converter is encapsulated in a low thermal resistance molding compound that has excellent resistance/electrical characteristics over a wide temperature range or in high humidity environments.
The encapsulant and unit case are both rated to UL 94V−0 flammability specifications.
Leads are tin plated for improved solderability.